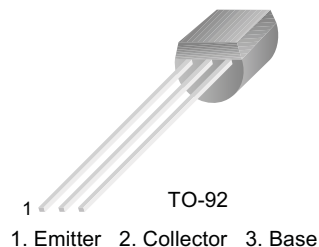


BC213L

BC213L

PNP General Purpose Amplifier

- This device is designed for use as general purpose amplifiers and switches requiring collector currents to 300mA.
- Sourced from process 68.
- See PN200 for Characteristics.



Absolute Maximum Ratings* $T_C=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Value | Units |
|----------------|--|------------|--------------------|
| V_{CEO} | Collector-Emitter Voltage | -30 | V |
| V_{CBO} | Collector-Base Voltage | -45 | V |
| V_{EBO} | Emitter-Base Voltage | -5.0 | V |
| I_C | Collector Current (DC) - Continuous | -500 | mA |
| T_J, T_{STG} | Operating and Storage Junction Temperature Range | - 55 ~ 150 | $^{\circ}\text{C}$ |

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

- 1) These ratings are based on a maximum junction temperature of 150 degrees C.
- 2) These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations

Electrical Characteristics $T_C=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Test Condition | Min. | Max. | Units |
|-------------------------------------|--------------------------------------|--|----------|---------------|-------|
| Off Characteristics | | | | | |
| $V_{(BR)CEO}$ | Collector-Emitter Voltage | $I_C = -2\text{mA}, I_B = 0$ | -30 | | V |
| $V_{(BR)CBO}$ | Collector-Base Voltage | $I_C = -10\mu\text{A}, I_E = 0$ | -45 | | V |
| $V_{(BR)EBO}$ | Emitter-Base Voltage | $I_E = -10\mu\text{A}, I_C = 0$ | -5.0 | | V |
| I_{CBO} | Collector Cut-off Current | $V_{CB} = -30\text{V}, I_E = 0$ | | -15 | nA |
| I_{EBO} | Emitter Cut-off Current | $V_{EB} = -4.0\text{V}, I_C = 0$ | | -15 | nA |
| On Characteristics * | | | | | |
| h_{FE} | DC Current Gain | $V_{CE} = -5\text{V}, I_C = -10\mu\text{A}$ $V_{CE} = -5\text{V}, I_C = -2.0\text{mA}$ | 40 80 | 400 | |
| $V_{CE(sat)}$ | Collector-Emitter Saturation Voltage | $I_C = -10\text{mA}, I_B = -0.5\text{mA}$ $I_C = -100\text{mA}, I_B = -5.0\text{mA}$ | | -0.25 -0.6 | V |
| $V_{BE(sat)}$ | Base-Emitter Saturation Voltage | $I_C = -100\text{mA}, I_B = -5.0\text{mA}$ | | -1.1 | V |
| $V_{BE(on)}$ | Base-Emitter On Voltage | $V_{CE} = -5.0\text{V}, I_C = -2.0\text{mA}$ | -0.6 | -0.72 | V |
| Small Signal Characteristics | | | | | |
| f_T | Current gain Bandwidth Product | $V_{CE} = -5.0\text{V}, I_C = -10\text{mA}$ $f = 100\text{MHz}$ | 200 | | MHz |
| NF | Noise Figure | $V_{CE} = -5.0\text{V}, I_C = -200\mu\text{A}$ $R_G = 2.0\text{k}\Omega, f = 1.0\text{KHz}$ | | 10 | dB |
| h_{fe} | Small Signal Current Gain | $I_C = -2.0\text{mA}, V_{CE} = -5.0\text{V}$ $f = 1.0\text{KHz}$ | 80 | | |

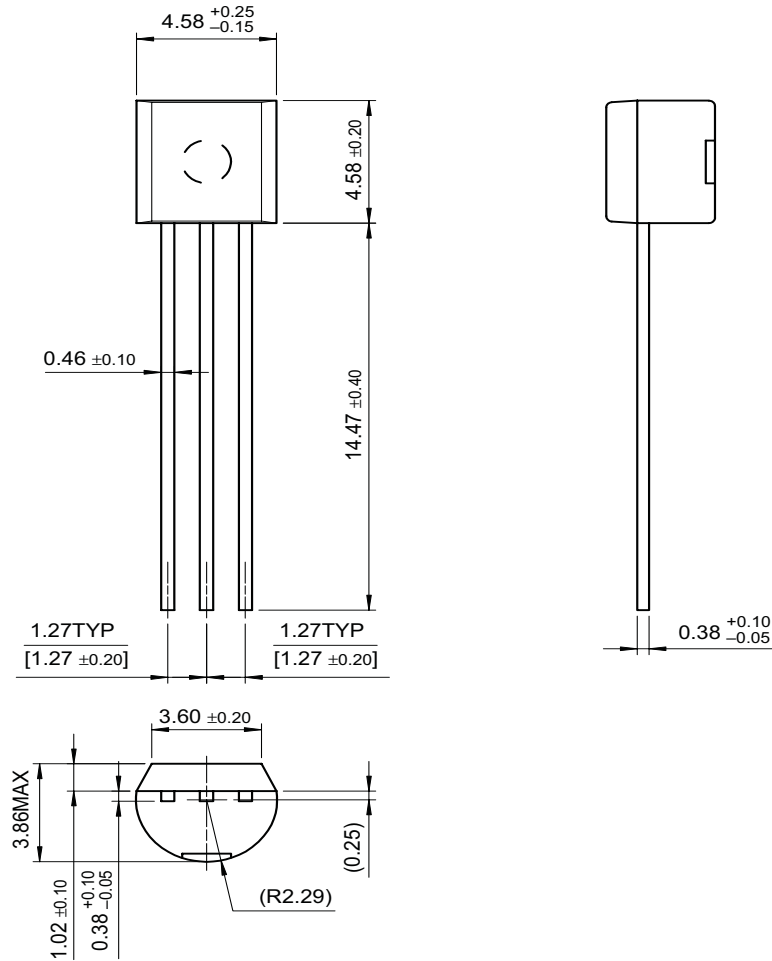
* Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2.0\%$

Thermal Characteristics $T_A=25^{\circ}\text{C}$ unless otherwise noted

| Symbol | Parameter | Max. | Units |
|-----------------|---|------|-----------------------------|
| P_D | Total Device Dissipation | 625 | mW |
| | Derate above 25°C | 5.0 | mW/ $^{\circ}\text{C}$ |
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case | 83.3 | $^{\circ}\text{C}/\text{W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient | 200 | $^{\circ}\text{C}/\text{W}$ |

Package Dimensions

TO-92



Dimensions in Millimeters

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PRODUCT STATUS DEFINITIONS

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|--------------------------|------------------------|---|
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